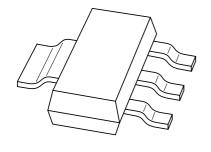
DISCRETE SEMICONDUCTORS

DATA SHEET



PBSS4540Z 40 V low V_{CEsat} NPN transistor

Product specification Supersedes data of 2001 Jul 24 2001 Nov 14





40 V low V_{CEsat} NPN transistor

PBSS4540Z

FEATURES

- Low collector-emitter saturation voltage
- High current capabilities
- Improved device reliability due to reduced heat generation.

APPLICATIONS

- Supply line switching circuits
- · Battery management applications
- DC/DC converter applications
- · Strobe flash units
- Heavy duty battery powered equipment (motor and lamp drivers)
- MOSFET driver applications.

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT223 plastic package. PNP complement: PBSS5540Z.

MARKING

TYPE NUMBER	MARKING CODE
PBSS4540Z	PB4540

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX	UNIT
V _{CEO}	emitter-collector voltage	40	V
I _C	collector current (DC)	5	Α
I _{CM}	peak collector current	10	Α
R _{CEsat}	equivalent on-resistance	<71	mΩ

PINNING

PIN	DESCRIPTION				
1	base				
2	collector				
3	emitter				
4	collector				

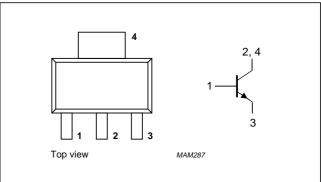


Fig.1 Simplified outline (SOT223) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT	
V _{CBO}	collector-base voltage	open emitter	_	40	V	
V _{CEO}	collector-emitter voltage	open base	_	40	V	
V _{EBO}	emitter-base voltage	open collector	_	6	V	
I _C	collector current (DC)		_	5	Α	
I _{CM}	peak collector current		_	10	Α	
I _{BM}	peak base current		_	2	Α	
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; notes 1 and 3	_	1.35	W	
		T _{amb} ≤ 25 °C; notes 2 and 3	_	2	W	
T _{stg}	storage temperature		-65	+150	°C	
T _j	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- 2. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm².
- 3. For other mounting conditions, see "Thermal considerations for SOT223 in the General Part of associated Handbook".

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to	note 1	92	K/W
	ambient	note 2	62.5	K/W

Notes

- 1. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm².
- $2. \quad \text{Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 6 cm2.}$

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CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

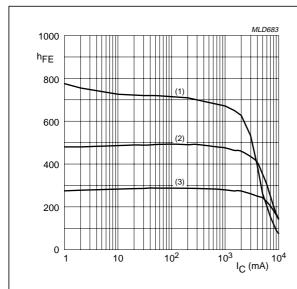
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 30 V; I _E = 0	_	_	100	nA
		V _{CB} = 30 V; I _E = 0; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	_	100	nA
h _{FE}	DC current gain	V _{CE} = 2 V; I _C = 500 mA	300	500	_	
		V _{CE} = 2 V; I _C = 1 A; note 1	300	500	_	
		V _{CE} = 2 V; I _C = 2 A; note 1	250	450	_	
		V _{CE} = 2 V; I _C = 5 A; note 1	100	300	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = 500 \text{ mA}; I_B = 5 \text{ mA}$	_	50	90	mV
		I _C = 1 A; I _B = 10 mA	_	75	120	mV
		I _C = 2 A; I _B = 200 mA	_	90	150	mV
		I _C = 5 A; I _B = 500 mA	_	210	355	mV
R _{CEsat}	equivalent on-resistance	$I_C = 5 \text{ A}$; $I_B = 500 \text{ mA}$; note 1	_	42	71	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 5 A; I _B = 500 mA	_	1.1	1.3	٧
V _{BEon}	base-emitter turn-on voltage	V _{CE} = 2 V; I _C =2 A	_	0.8	1.1	V
f _T	transition frequency	I _C = 100 mA; V _{CE} = 10 V; f = 100 MHz	70	130	_	MHz
C _c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0;$ f = 1 MHz	_	60	75	pF

Note

1. Pulse test: $t_p \le 300~\mu s;~\delta \le 0.02.$

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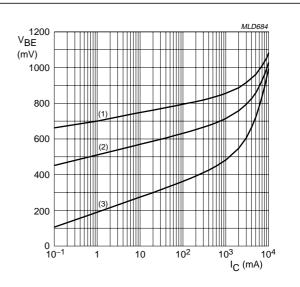
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 $V_{CE} = 2 V$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) T_{amb} = 25 °C.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

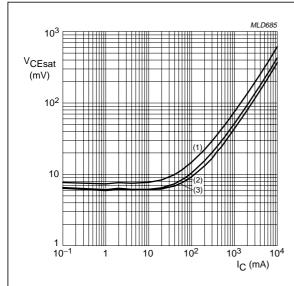
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = 2 V.$

- (1) $T_{amb} = -55 \,^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = 150 \, ^{\circ}C$.

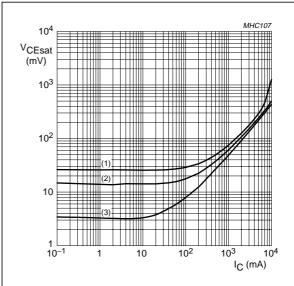
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 20$.

- (1) $T_{amb} = 150 \, ^{\circ}C$.
- (2) $T_{amb} = 25 \, ^{\circ}C$.
- (3) $T_{amb} = -55 \, ^{\circ}C$.

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



 $T_{amb} = 25 \, ^{\circ}C.$

- (1) $I_C/I_B = 100$
- (2) $I_C/I_B = 50$.
- (3) $I_C/I_B = 10$.

Fig.5 Collector-emitter saturation voltage as a function of collector current; typical values.

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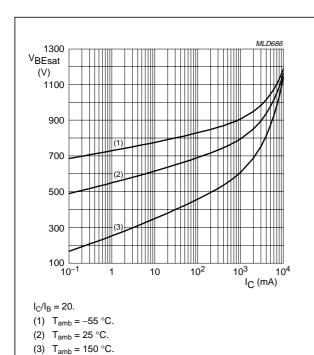
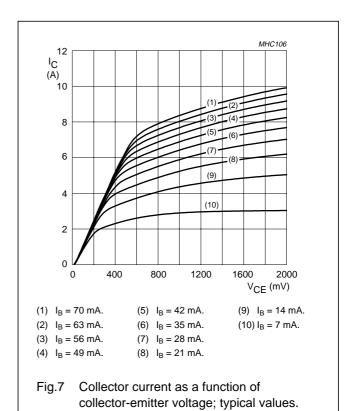
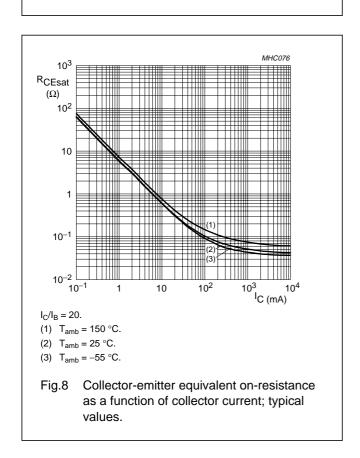


Fig.6 Base-emitter saturation voltage as a function of collector current; typical values.





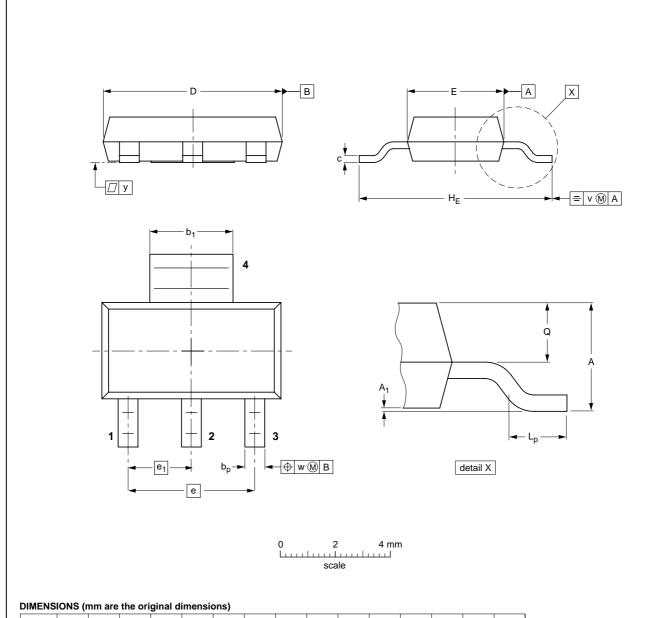
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PACKAGE OUTLINE

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

SOT223



UNIT	A	A ₁	bp	b ₁	С	D	E	е	e ₁	HE	Lp	Q	v	w	у
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT223			SC-73			97-02-28 99-09-13

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DATA SHEET STATUS

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Printed in The Netherlands

613514/03/pp12

Date of release: 2001 Nov 14

Document order number: 9397 750 08736

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